



The VPX Development System enables development on Connect Tech's field-deployable VPX line of 3U SOSA-aligned modules. Fully stackable, the system is designed to enable single or interconnected modules for scalable system development. Active cooling is provided by four variable-speed and remote-controlled fans.



By allowing for development on the rugged Graphite VPX, powered by the NVIDIA Jetson AGX Orin, the system accelerates time to market, single source development and ease of access to the same hardware certified for the field.

Compact and lightweight, it is designed to help teams get cards up and running quickly, without the complexity of backplane design or custom interconnects.

FEATURES

- ✓ SOSA-aligned 3U / 1-slot VPX chassis
- ✓ Compact and rugged design
- ✓ Rear Transition Module (RTM) with full I/O access
- ✓ Flexible deployment as a standalone or stackable system
- ✓ Four-fan active cooling with variable speed control via wireless remote
- ✓ Single-slot backplane with RT3 connectors supporting 12V & 3V3_AUX

SPECIFICATIONS

NVIDIA GPU SoC Module Compatibility	NVIDIA® Jetson AGX Orin™ Industrial	Interface	14.2.16 IO Intensive Slot Profile 3U 1.0" Pitch Conduction Cooled
IPMC	Tier 1, 2 and 3 support	Data Plane Expansion Plane	Root Port and End Point Support 1x PCIe Gen4 x8 with support for bifurcation *Not accessible via RTM*
Networking	1x 10GBase-KR (SAMTEC ARC) 1x 1Gbase-T (IX)	Display Output	1x DisplayPort
USB	1x USB 2.0 (Type A) 1x USB 3.0 (Type A) 1x USB 3.2 Gen2x1 OTG (Type-C, Front Panel)	Storage	2TB (Other storage options available)
UART/Serial	1x USB console port (micro USB) 2x RS232 (Pin Header)	Misc/IO	4x GPIO
Input Power	+12V, +3V3AUX	Operating Temperature	0°C to +70°C (+32°F to +158°F)
Chassis Specifications	Powder-coated steel chassis with aluminum conduction-cooled card guides and acrylic top panel Dimensions: 309.78 x 298.2 x 86.43 mm (12.2" x 11.74" x 3.4"); Weight: 5kg (11 lbs)	Warranty and Support	1 Year Warranty and Free Technical Support

